

# FLEX-BX200-Q370

Intel® Coffee Lake AI 模块化 嵌入式工控机



## Features

- » 2U AI Modular PC with 8th/9th Generation LGA 1151 Intel® Core™ i7/i5/i3 and Pentium® processor
- » Four hot-swappable and accessible HDD drive bays, support RAID 0/1/5/10
- » Two PCIe 3.0 by 4 and two PCIe 3.0 by 8 slots
- » Dual M.2 2280 PCIe Gen 3.0 x4 NVMe™ SSD support
- » QTS-Gateway support
- » Modular LCD panel kit design. Please refer [FLEX-PLKIT Selection](#)



## Specifications

<b>Form factor</b>	
SBC Form Factor	8th/9th Generation Intel Core™ i7/i5/i3 processors in the LGA 1151
	Intel® 300 Series Chipsets Q370
	FLEX AI Modular Box PC
<b>I/O Interface</b>	
I/O Ports	1 x HDMI™ output
	2 x GbE LAN
	6 x USB 3.0 Type-A
	2 x RS-232 DB-9 type
	1 x Mic in
	1 x Line out
	1 x AC power in Inlet
<b>Expansion Slots</b>	
Expansion Slots	2 x PCIe 3.0 by 8 (by 16 slot)
	2 x PCIe 3.0 by 4 (maximum card size supported: 68 mm x 167 mm)
<b>System</b>	
Cooling method / System Fan	System fan
Drive Bays	4 x Accessible 2.5" SATA 6Gb/s HDD/SSD bay (RAID 0/1/5/10 support)
<b>Indicator&amp;Buttons</b>	
Buttons	Power button with power LED (power on=Blue)
	AT/ATX mode switch
	Reset button
<b>Color</b>	
Color	Black C
<b>Dimensions</b>	
Dimensions	357 x 230 x 88
<b>Weight</b>	
Weight	4kg
<b>Environment</b>	

Operating Temperature	-20°C ~ 50°C (with SSD and TDP 65W processor)
	-20°C ~ 40°C (with HDD or add-on cards without fan)
Humidity	5% ~95%, non-condensing

## Ordering Information

FLEX-BX200-Q370-i3/25-R10	2U AI Modular BOX PC, Intel® Core™ i3-8100T Processor (4-core, 4-thread, 3.10 GHz) TDP 35W, 2xPCIex4 and 2xPCIex8 slots, 4x HDD bay, 250W PSU, R10
FLEX-BX200-Q370-P/25-R10	2U AI Modular BOX PC, Intel® Pentium® Gold G5400T Processor (2-core, 4-thread, 3.10 GHz) TDP 35W, 2xPCIex4 and 2xPCIex8 slots, 4x HDD bay, 250W PSU, R10

## Packing List

Power cord	HDD door key
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